

HSF



RoHS

SPECIFICATION

Current Rating:3.0AMP

Insulation Resistance:1000MΩ MIN

Contact Resistance:20MΩ MAX

Withstand Voltage:500V AC/DC

Operating Temperature:-40° C to +105° C

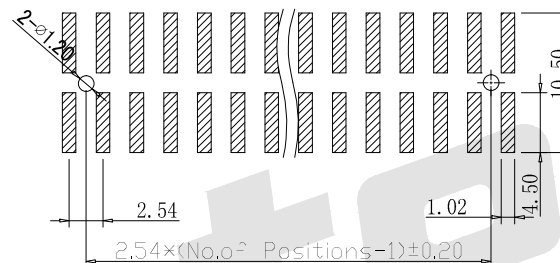
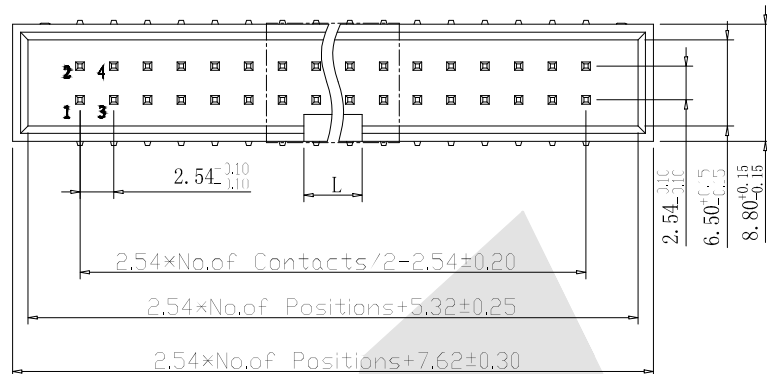
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:PA6T UL 94V-0

Recommended P.C.B Layout (Top Side)

(PCB BOARD TOLERANCE±0.05)



Ordering Code:

BHDM04 - X - X - X - X - X
① ② ③ ④ ⑤ ⑥

① Series No:

② No. of Contacts

06 08 10 12 14 16 18

20 22 24 26 28 30 32

34 36 40 44 48 50 60

64

③ Contact Plating:

G0:Gold flash S0:Selective

G1:3U" Gold S1:Selective 3u"

G2:5u" Gold S2:Selective 5u"

G3:10u" Gold S3:Selective 10u"

G4:15u" Gold S4:Selective 15u"

G5:30u" Gold S5:Selective 30u"

SN:Tin

④ Color Insulator

B:Black

U:Blue

G:Gray

⑤ Insulator Material

B:PA6T

C:LCP

E:PA9T

⑥ Packing

A:Tray

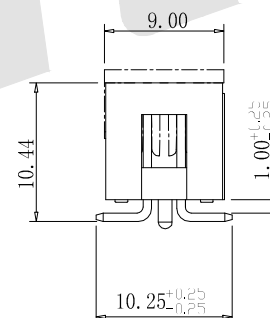
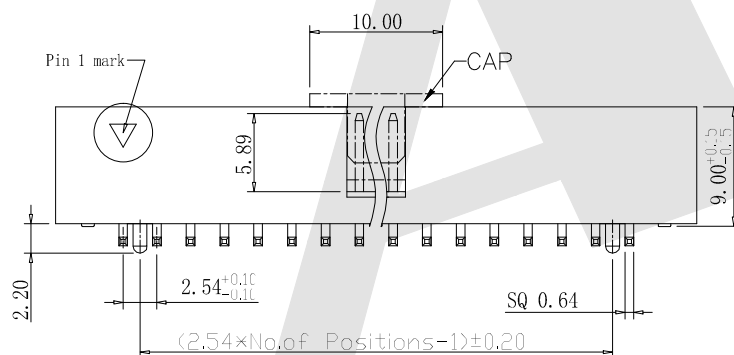
B:Bag

T:Tube

U:Tube+CAP

R:Tape&Reel

W:Tape&Reel+CAP



Unless Otherwise specified tolerance

X. ±0.35 X.XX: ±0.20

X.X: ±0.25 X.XXX: ±0.15

SCALE:

As Shown

UNIT:

mm

DRAW

Wu Feng Rong

DATE

27/04/2020

CHECK

BobYang

DATE

27/04/2020



3rd ANGLE PROJECTION



ANTENK ELECTRONICS CO., LTD

Http://www.antenk.com

E-mail:sales@antenk.com

TITLE:

2.54mm Box Header SMT H=9.0 with Post

DRAWING NO:

BHDM04-XXXXX

PRODUCT NO:

BHDM04-XXXXX

REV

DESCRIPTION

DATE

1

2

3

4

5

6

7

8